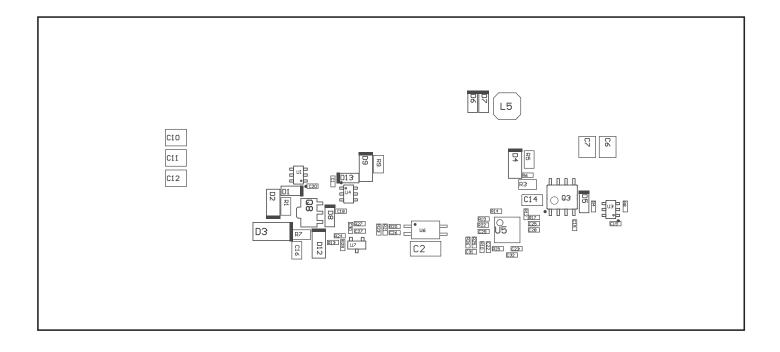


COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED. ASSEMBLY VARIANT: 001

PCB VIEWED FROM TOP SIDE	BOARD #: PMP9720	REV: A	SVN REV:	: Not In VersionControl
IGNORE -> Top Overlay				
PLOT NAME = Top Assembly Drawing	GENERATED : 5/20/2	2014 12:23:50	PM	TEXAS INSTRUMENTS



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED. ASSEMBLY VARIANT: 001

PCB VIEWED FROM BOTTOM SIDE	BOARD #: PMP9720	REV: A	SVN REV:	Not In VersionControl
	Bottom Overlay <- ANNAI			Bottom Ove
PLOT NAME = Bottom Assembly Drawing	GENERATED : 5/20/2	2014 12:23:51	PM	TEXAS INSTRUMENTS

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